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Electronic Patent Application Submission  
USPTO Use Only

EFS ID: 64280

Application ID: 10766046



Title of Invention: LEADFRAME TYPE  
SEMICONDUCTOR PACKAGE  
HAVING REDUCED INDUCTANCE  
AND ITS MANUFACTURING  
METHOD

First Named Inventor: GI KIM

Domestic/Foreign Application: Domestic Application

Filing Date: 2004-01-28

Effective Receipt Date: 2004-07-09

Submission Type: Information Disclosure  
Statement

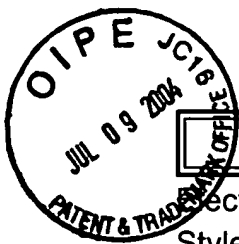
Filing Type:

Confirmation number: 2288


Attorney Docket Number: AMKOR099

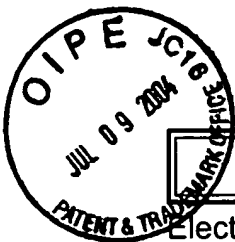
Total Fees Authorized:

Digital Certificate Holder: cn=Mark B. Garred,ou=Registered Attorneys,ou=Patent and Trademark  
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**TRANSMITTAL**

Electronic Version v1.1  
Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>LEADFRAME TYPE SEMICONDUCTOR PACKAGE HAVING REDUCED INDUCTANCE AND ITS MANUFACTURING METHOD</b>									
<p>Application Number: 10/766046 </p> <p>Date: 2004-01-28</p> <p>First Named Applicant: GI JEONG KIM</p> <p>Confirmation Number: 2288</p> <p>Attorney Docket Number: AMKOR099</p>										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>MARK B. GARRED Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids6-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	ids6-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	ids6-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
<b>Comments</b>										



# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of  
Invention

LEADFRAME TYPE SEMICONDUCTOR PACKAGE  
HAVING REDUCED INDUCTANCE AND ITS  
MANUFACTURING METHOD

Application Number: 10/766046



Confirmation Number: 2288

First Named Applicant: GI KIM

Attorney Docket Number: AMKOR099

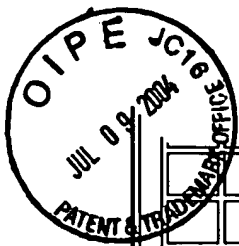
Art Unit: 2613

Search string: ( 6348726 or 6355502 or 6369447 or 6369454  
or 6373127 or 6380048 or 6384472 or 6388336  
or 6395578 or 6410979 or 6400004 or 6414385  
or 6420779 or 6429508 or 6437429 or 6444499  
or 6448633 or 6452279 or 6459148 or 6464121  
or 6476469 or 6476474 or 6482680 or 6498099  
or 6498392 or 6507096 or 6507120 or 6534849  
or 6545332 or 6545345 or 6559525 or 6566168  
or 6583503 or 6603196 or 6667546 or  
6624005 ).pn.

## US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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	2	6355502	2002-03-12	Kang et al.			
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	36	6624005	2003-09-23	Di Caprio et al

Signature

Examiner Name	Date